SiA923AEDJ



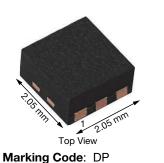
Vishay Siliconix

Dual P-Channel 20 V (D-S) MOSFET

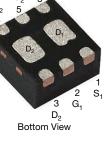
PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) MAX.	I _D (A)	Q _g (TYP.)		
-20	0.054 at V _{GS} = -4.5 V	-4.5 ^a			
	0.070 at V _{GS} = -2.5 V	-4.5 ^a	9.5 nC		
	0.104 at V _{GS} = -1.8 V	-4.5 ^a	9.5 110		
	0.165 at V _{GS} = -1.5 V	-1.5			

PowerPAK[®] SC-70-6L Dual

SiA923AEDJ-T1-GE3 (Lead (Pb)-free and Halogen-free)



Ordering Information:

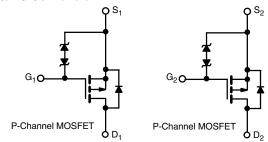


FEATURES

- TrenchFET[®] Power MOSFET
- Thermally Enhanced PowerPAK[®] SC-70 Package
 Small Footprint Area
- Low On-Resistance
- Typical ESD Protection: 2500 V
- 100 % R_q Tested
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Charger Switches and Load Switches for Portable Devices
- DC/DC Converters



PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	-20	V	
Gate-Source Voltage		V _{GS}	± 8		
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C		-4.5 ^a		
	T _C = 70 °C		-4.5 ^a		
	T _A = 25 °C	I _D	-4.5 ^{a,b,c}		
	T _A = 70 °C		-4.5 ^{a,b,c}	А	
Pulsed Drain Current (t = 100 μs)		I _{DM}	-15		
Continuous Source-Drain Diode Current	T _C = 25 °C		-4.5 ^a		
	T _A = 25 °C	I _S	-1.6 ^{b,c}	1	
	T _C = 25 °C		7.8		
Maximum Power Dissipation	T _C = 70 °C		5		
	T _A = 25 °C	P _D	1.9 ^{b,c}	— W	
	T _A = 70 °C		1.2 ^{b,c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150	*0	
Soldering Recommendations (Peak Temperature) d,e			260		

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum Junction-to-Ambient ^{b,f}	t≤5 s	R _{thJA}	52	65	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	12.5	16	0,0	

Notes

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: Manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 110 °C/W.

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RoHS

COMPLIANT

HALOGEN

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SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless othe	erwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I_D = -250 μ A	-20	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$			-15	-	mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			2.5	-		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-0.4	-	-0.9	V	
Cata Source Leakage	1	V_{DS} = 0 V, V_{GS} = ± 4.5 V	-	± 0.3	± 3		
Gate-Source Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 8 V	-	± 3	± 30	<u>ا</u>	
Zarra Oata Valtarra David O anad		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μA	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-10	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \leq$ -5 V, V_{GS} = -4.5 V	-15	-	-	Α	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3.8 \text{ A}$	-	0.044	0.054	1	
Drain Source On State Desistance a	Б	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -3.3 \text{ A}$	-	0.057	0.070	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = -1.8 V, I _D = -1 A	-	0.075	0.104		
		$V_{GS} = -1.5 \text{ V}, \text{ I}_{D} = -0.5 \text{ A}$	-	0.097	0.165		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -3.8 \text{ A}$	-	11	-	S	
Dynamic ^b		·			•		
Input Capacitance	Ciss		-	770	-	pF	
Output Capacitance	C _{oss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	-	90	-		
Reverse Transfer Capacitance	C _{rss}		-	81	-		
Tatal Cata Charge	Qg	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -8 \text{ V}, \text{ I}_{D} = -4.9 \text{ A}$	-	16.3	25	nC	
Total Gate Charge			-	9.5	14.5		
Gate-Source Charge	Q _{gs}	V_{DS} = -10 V, V_{GS} = -4.5 V, I_D = -4.9 A	-	1.4	-		
Gate-Drain Charge	Q _{gd}		-	2.3	-		
Gate Resistance	Rg	f = 1 MHz	1	5.1	10	Ω	
Turn-On Delay Time	t _{d(on)}		-	15	25		
Rise Time	tr	V_{DD} = -10 V, R _L = 2.6 Ω	-	16	25	- ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -3.9$ Å, $V_{GEN} = -4.5$ V, $R_g = 1 \ \Omega$	-	30	45		
Fall Time	t _f		-	10	15		
Turn-On Delay Time	t _{d(on)}		-	7	15		
Rise Time	t _r	$V_{DD} = -10 \text{ V}, \text{ R}_{L} = 2.6 \Omega$		12	20]	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ -3.9 A, V_GEN = -8 V, R_g = 1 Ω	-	26	40	-	
Fall Time	t _f		-	10	15		
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C	-	-	-4.5	^	
Pulse Diode Forward Current	I _{SM}		-	-	-15	A	
Body Diode Voltage	V _{SD}	$I_{\rm S}$ = -3.9 A, $V_{\rm GS}$ = 0 V	-	-0.9	-1.2	V	
Body Diode Reverse Recovery Time	t _{rr}		-	13	25	ns	
Body Diode Reverse Recovery Charge	Q _{rr}		-	5.5	12	nC	
Reverse Recovery Fall Time	ta	I _F = -3.9 A, dl/dt = 100 A/μs, T _J = 25 °C	-	7.5	-	- ns	
Reverse Recovery Rise Time	t _b	1	-	5.5	-		

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

20 10 0 0 3 6 9 12 15 V_{GS} - Gate-to-Source Voltage (V)

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

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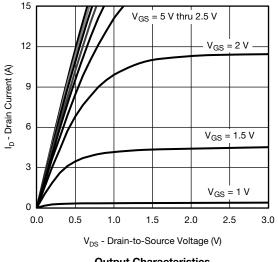
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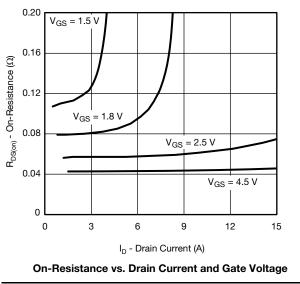
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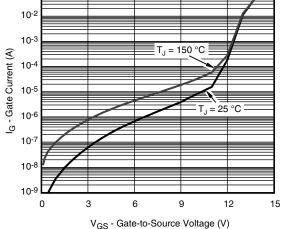
I_G - Gate Current (mA)

Gate Current vs. Gate-to-Source Voltage



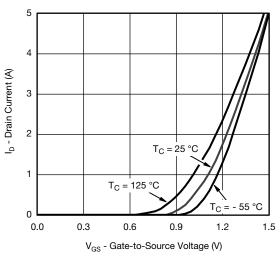




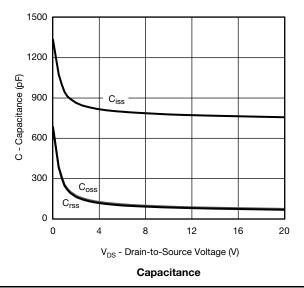


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Gate Current vs. Gate-to-Source Voltage







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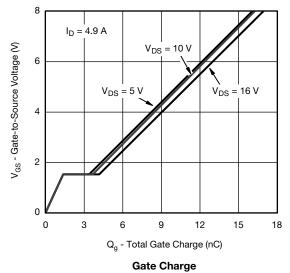
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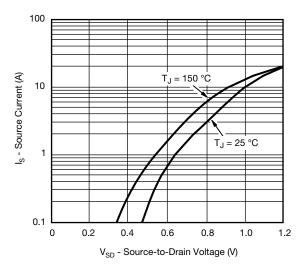
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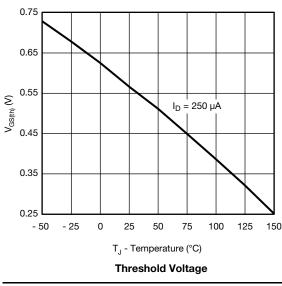
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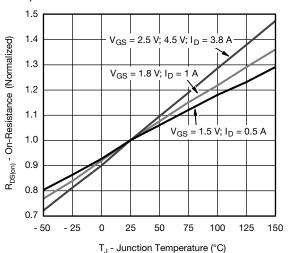
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



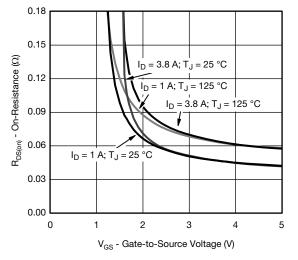




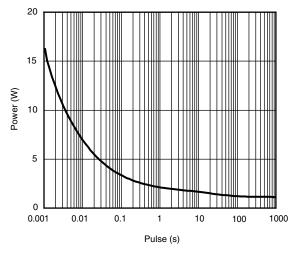




On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

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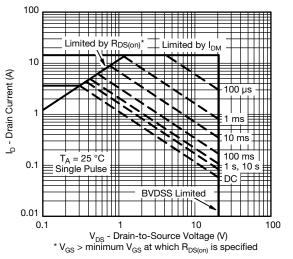
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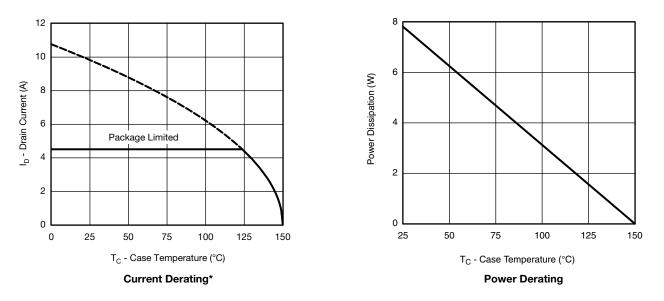
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient

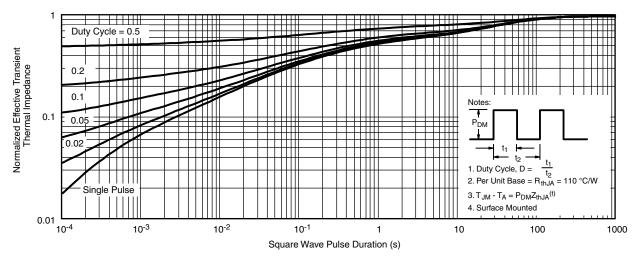


* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

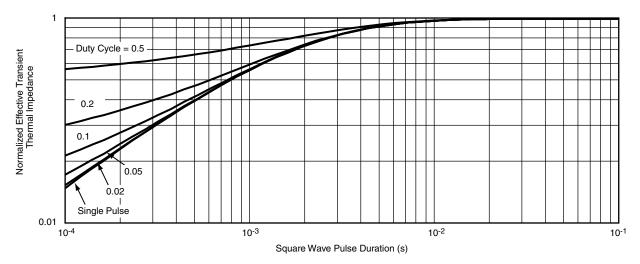


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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